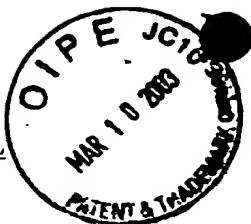


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(S) DAC #4

09/904,084

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Dongming Zhu et al.

Title: LOW CONDUCTIVITY AND SINTERING-RESISTANT THERMAL
BARRIER COATINGS

Serial No.: 09/904,084

Filing Date: July 12, 2001

Docket No.: 33253US1

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OFFICE OF PETITIONS

CORRECTION OF ENTITY STATUS AND DEFICIENCY PAYMENT

Commissioner for Patents
Washington, D.C. 20231

Sir:

This paper is filed under 37 C.F.R. 1.28(c). The above-identified application was filed with a good-faith claim to small-entity status. This claim was made through payment of the small-entity filing fee. This fee was paid in good faith. It was subsequently discovered that status as a small entity was established in error. This application is not entitled to small-entity status. An itemized list of fees erroneously paid as a small entity follows:

Adjustment date: 03/12/2003 SLUANG1
07/17/2001 JBALINAN 00000045 09904084
01 FC:201 -355.00 OP

03/12/2003 SLUANG1 00000038 09904084
01 FC:1001 750.00 OP

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Commissioner for Patents, Washington D.C. 20231 on the date indicated below.

Brian Alan Bargmeyer

Name of Attorney for Applicant(s)

March 3, 2003

Date

Signature of Attorney

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09/904,084

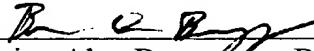
1. Nonprovisional patent application basic filing fee – \$355.00, paid on July 12, 2001;
Deficiency amount owed for this fee: \$395.00

The total deficiency amount owed in this application is \$395.00. A check in this amount is enclosed herewith. If there are any fees required by this communication not covered by the enclosed check, please charge such fees to our Deposit Account No. 16-0820, Order No. 33253US1.

Respectfully submitted,

PEARNE & GORDON LLP

By



Brian Alan Bargmeyer, Reg. No. 47404

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Date: March 3, 2003